

IRISH STANDARD

I.S. EN 60749-14:2003

ICS 31.080.01

**SEMICONDUCTOR DEVICES -**

**MECHANICAL AND CLIMATIC TEST** 

**METHODS** 

**PART 14: ROBUSTNESS OF TERMINATIONS** 

(LEAD INTEGRITY)

((EC 60749-14:2003)

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## **EUROPEAN STANDARD**

### EN 60749-14

NORME EUROPÉENNE

**EUROPÄISCHE NORM** 

October 2003

ICS 31.080.01

English version

# Semiconductor devices Mechanical and climatic test methods Part 14: Robustness of terminations (lead integrity)

(IEC 60749-14:2003)

Dispositifs à semiconducteurs -Méthodes d'essais mécaniques et climatiques Partie 14: Robustesse des sorties (intégrité des connexions) (CEI 60749-14:2003) Halbleiterbauelemente Mechanische und klimatische
Prüfverfahren
Teil 14: Festigkeit der
Bauelementeanschlüsse
(Unversehrtheit der Anschlüsse)
(IEC 60749-14:2003)

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## **CENELEC**

European Committee for Electrotechnical Standardization Comité Européen de Normalisation Electrotechnique Europäisches Komitee für Elektrotechnische Normung

Central Secretariat: rue de Stassart 35, B - 1050 Brussels

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#### **Foreword**

The text of document 47/1701/FDIS, future edition 1 of IEC 60749-14, prepared by IEC TC 47, Semiconductor devices, was submitted to the IEC-CENELEC parallel vote and was approved by CENELEC as EN 60749-14 on 2003-10-01.

The following dates were fixed:

 latest date by which the EN has to be implemented at national level by publication of an identical national standard or by endorsement

(dop) 2004-07-01

 latest date by which the national standards conflicting with the EN have to be withdrawn

(dow) 2006-10-01

Annexes designated "normative" are part of the body of the standard. In this standard, annex ZA is normative.

Annex ZA has been added by CENELEC.

#### **Endorsement notice**

The text of the International Standard IEC 60749-14:2003 was approved by CENELEC as a European Standard without any modification.

# Annex ZA (normative)

# Normative references to international publications with their corresponding European publications

This European Standard incorporates by dated or undated reference, provisions from other publications. These normative references are cited at the appropriate places in the text and the publications are listed hereafter. For dated references, subsequent amendments to or revisions of any of these publications apply to this European Standard only when incorporated in it by amendment or revision. For undated references the latest edition of the publication referred to applies (including amendments).

NOTE When an international publication has been modified by common modifications, indicated by (mod), the relevant EN/HD applies.

<u>Publication</u>	<u>Year</u>	<u>Title</u>	EN/HD	<u>Year</u>
IEC 60749-8	<b>-</b> <sup>1)</sup>	Semiconductor devices - Mechanical and climatic test methods Part 8: Sealing	EN 60749-8	2003 2)

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<sup>1)</sup> Undated reference.

<sup>&</sup>lt;sup>2)</sup> Valid edition at date of issue.

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